## **Baseplates pre-production status**

- Shipping and production schedule:
  - $\circ \quad \underline{\text{Nov 4, 24: 50 Full-CuW, 10 Full-Ti}} \rightarrow \underline{44 \text{ CuW, 16 Ti?}}$
  - Dec 2, 24: 70 Full-CuW, 50 Full-Ti
  - Feb 3, 25: 184 Full-CuW, 40 Full-Ti, 16 Bottom-Ti
  - Mar 3, 25: 155 Full-CuW, 78 Full-Ti, 8 Bottom-Ti, remaining 48 CuW and 48 Ti partials
- Delivery status:
  - 39/44 CuW plates have been laminated
  - $\circ$  0/16 Ti plates have been laminated
- Important notes:
  - We want to re-check the quality of the laminated plates before applying glue tape
  - We have a very basic dispensing program for Ti. Maybe not good enough. Full glue?
- Glue tape to apply on kapton for full baseplates arrived yesterday
  - Is it the same for left/right, i.e., we should rotate it according to the target position?

## Feedback from Tobias and Stefan

Stefan and Tobias came to the clean room and check the procedure we follow

- The bend plate "collapses" when kapton is applied on top of it and the vacuum system turned on
  - Need to turn the bend plate screw even just to have a flat-ish plate
- The flatness measurements we perform are more thickness measurements
  - $\circ$   $\,$   $\,$  Need to put the base plate on three pins and not directly on the table
  - $\circ$  The 10-points sampling is not dense enough  $\rightarrow$  better to drag the flatness tool along the plate
- Microcalipers must always be moved such as the last movement is "pushing", otherwise we may not get the results we expected
- Hybrid method: how do we choose how much glue we dispense in the slits of the glue tape?
  - We can select how many g/sec of glue we dispense and adjust to have 50 micron thickness
- The current baseplate jig is too heavy for the gluing machine  $\rightarrow$  it is not flat
  - We have a jig dedicated to the gluing machine to avoid this problem
- We should learn how to program the gluing machine using the PC instead of the remote